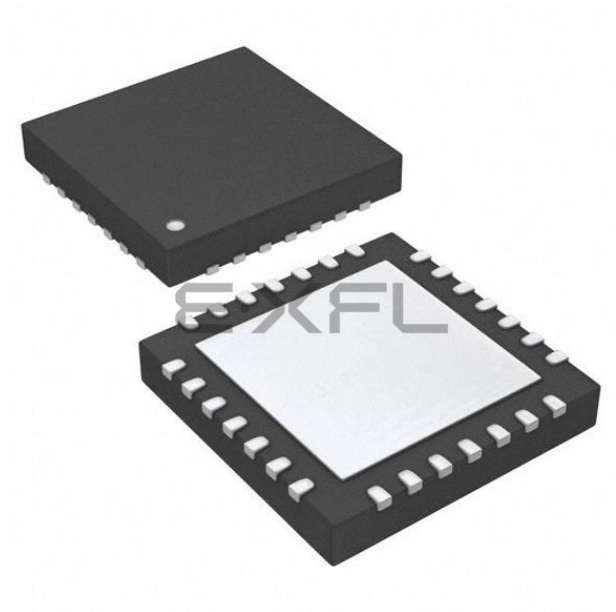

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 11x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf737t-i-ml

1.0 DEVICE OVERVIEW

This document contains device specific information about the following devices:

- PIC16F737
- PIC16F747
- PIC16F767
- PIC16F777

PIC16F737/767 devices are available only in 28-pin packages, while PIC16F747/777 devices are available in 40-pin and 44-pin packages. All devices in the PIC16F7X7 family share common architecture with the following differences:

- The PIC16F737 and PIC16F767 have one-half of the total on-chip memory of the PIC16F747 and PIC16F777.
- The 28-pin devices have 3 I/O ports, while the 40/44-pin devices have 5.
- The 28-pin devices have 16 interrupts, while the 40/44-pin devices have 17.
- The 28-pin devices have 11 A/D input channels, while the 40/44-pin devices have 14.
- The Parallel Slave Port is implemented only on the 40/44-pin devices.
- Low-Power modes: RC_RUN allows the core and peripherals to be clocked from the INTRC, while SEC_RUN allows the core and peripherals to be clocked from the low-power Timer1. Refer to **Section 4.7 "Power-Managed Modes"** for further details.
- Internal RC oscillator with eight selectable frequencies, including 31.25 kHz, 125 kHz, 250 kHz, 500 kHz, 1 MHz, 2 MHz, 4 MHz and 8 MHz. The INTRC can be configured as a primary or secondary clock source. Refer to **Section 4.5 "Internal Oscillator Block"** for further details.
- The Timer1 module current consumption has been greatly reduced from 20 μA (previous PIC16 devices) to 1.8 μA typical (32 kHz at 2V), which is ideal for real-time clock applications. Refer to **Section 7.0 "Timer1 Module"** for further details.
- Extended Watchdog Timer (WDT) that can have a programmable period from 1 ms to 268s. The WDT has its own 16-bit prescaler. Refer to **Section 15.17 "Watchdog Timer (WDT)"** for further details.
- Two-Speed Start-up: When the oscillator is configured for LP, XT or HS, this feature will clock the device from the INTRC while the oscillator is warming up. This, in turn, will enable almost immediate code execution. Refer to **Section 15.17.3 "Two-Speed Clock Start-up Mode"** for further details.
- Fail-Safe Clock Monitor: This feature will allow the device to continue operation if the primary or secondary clock source fails by switching over to the INTRC.

The available features are summarized in Table 1-1. Block diagrams of the PIC16F737/767 and PIC16F747/777 devices are provided in Figure 1-1 and Figure 1-2, respectively. The pinouts for these device families are listed in Table 1-2 and Table 1-3.

Additional information may be found in the *"PIC® Mid-Range MCU Family Reference Manual"* (DS33023) which may be obtained from your local Microchip Sales Representative or downloaded from the Microchip web site. The Reference Manual should be considered a complementary document to this data sheet and is highly recommended reading for a better understanding of the device architecture and operation of the peripheral modules.

TABLE 1-1: PIC16F7X7 DEVICE FEATURES

Key Features	PIC16F737	PIC16F747	PIC16F767	PIC16F777
Operating Frequency	DC – 20 MHz	DC – 20 MHz	DC – 20 MHz	DC – 20 MHz
Resets (and Delays)	POR, BOR (PWRT, OST)	POR, BOR (PWRT, OST)	POR, BOR (PWRT, OST)	POR, BOR (PWRT, OST)
Flash Program Memory (14-bit words)	4K	4K	8K	8K
Data Memory (bytes)	368	368	368	368
Interrupts	16	17	16	17
I/O Ports	Ports A, B, C	Ports A, B, C, D, E	Ports A, B, C	Ports A, B, C, D, E
Timers	3	3	3	3
Capture/Compare/PWM Modules	3	3	3	3
Master Serial Communications	MSSP, AUSART	MSSP, AUSART	MSSP, AUSART	MSSP, AUSART
Parallel Communications	—	PSP	—	PSP
10-bit Analog-to-Digital Module	11 Input Channels	14 Input Channels	11 Input Channels	14 Input Channels
Instruction Set	35 Instructions	35 Instructions	35 Instructions	35 Instructions
Packaging	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 44-pin QFN 44-pin TQFP	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 44-pin QFN 44-pin TQFP

TABLE 1-3: PIC16F747 AND PIC16F777 PINOUT DESCRIPTION (CONTINUED)

Pin Name	PDIP Pin #	QFN Pin #	TQFP Pin #	I/O/P Type	Buffer Type	Description
						PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT/AN12	33	9	8		TTL/ST(1)	
RB0				I/O		Digital I/O.
INT				I		External interrupt.
AN12				I		Analog input channel 12.
RB1/AN10	34	10	9		TTL	
RB1				I/O		Digital I/O.
AN10				I		Analog input channel 10.
RB2/AN8	35	11	10		TTL	
RB2				I/O		Digital I/O.
AN8				I		Analog input channel 8.
RB3/CCP2/AN9	36	12	11		TTL	
RB3				I/O		Digital I/O.
CCP2(5)				I/O		CCP2 capture input, compare output, PWM output.
AN9				I		Analog input channel 9.
RB4/AN11	37	14	14		TTL	
RB4				I/O		Digital I/O.
AN11				I		Analog input channel 11
RB5/AN13/CCP3	38	15	15		TTL	
RB5				I/O		Digital I/O.
AN13				I		Analog input channel 13.
CCP3				I		CCP3 capture input, compare output, PWM output.
RB6/PGC	39	16	16		TTL/ST(2)	
RB6				I/O		Digital I/O.
PGC				I/O		In-Circuit Debugger and ICSP™ programming clock.
RB7/PGD	40	17	17		TTL/ST(2)	
RB7				I/O		Digital I/O.
PGD				I/O		In-Circuit Debugger and ICSP programming data.

Legend: I = input O = output I/O = input/output P = power
— = Not used TTL = TTL input ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as an external interrupt.
2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.
3: This buffer is a Schmitt Trigger input when configured as a general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).
4: This buffer is a Schmitt Trigger input when configured in RC Oscillator mode and a CMOS input otherwise.
5: Pin location of CCP2 is determined by the CCPMX bit in Configuration Word Register 1.

TABLE 1-3: PIC16F747 AND PIC16F777 PINOUT DESCRIPTION (CONTINUED)

Pin Name	PDIP Pin #	QFN Pin #	TQFP Pin #	I/O/P Type	Buffer Type	Description
						PORTC is a bidirectional I/O port.
RC0/T1OSO/T1CKI	15	34	32		ST	
RC0				I/O		Digital I/O.
T1OSO				O		Timer1 oscillator output.
T1CKI				I		Timer1 external clock input.
RC1/T1OSI/CCP2	16	35	35		ST	
RC1				I/O		Digital I/O.
T1OSI				I		Timer1 oscillator input.
CCP2(5)				I/O		Capture 2 input, Compare 2 output, PWM 2 output.
RC2/CCP1	17	36	36		ST	
RC2				I/O		Digital I/O.
CCP1				I/O		Capture 1 input, Compare 1 output, PWM 1 output.
RC3/SCK/SCL	18	37	37		ST	
RC3				I/O		Digital I/O.
SCK				I/O		Synchronous serial clock input/output for SPI mode.
SCL				I/O		Synchronous serial clock input/output for I^2C™ mode.
RC4/SDI/SDA	23	42	42		ST	
RC4				I/O		Digital I/O.
SDI				I		SPI data in.
SDA				I/O		I^2C data I/O.
RC5/SDO	24	43	43		ST	
RC5				I/O		Digital I/O.
SDO				O		SPI data out.
RC6/TX/CK	25	44	44		ST	
RC6				I/O		Digital I/O.
TX				O		AUSART asynchronous transmit.
CK				I/O		AUSART synchronous clock.
RC7/RX/DT	26	1	1		ST	
RC7				I/O		Digital I/O.
RX				I		AUSART asynchronous receive.
DT				I/O		AUSART synchronous data.

Legend: I = input O = output I/O = input/output P = power
— = Not used TTL = TTL input ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as an external interrupt.

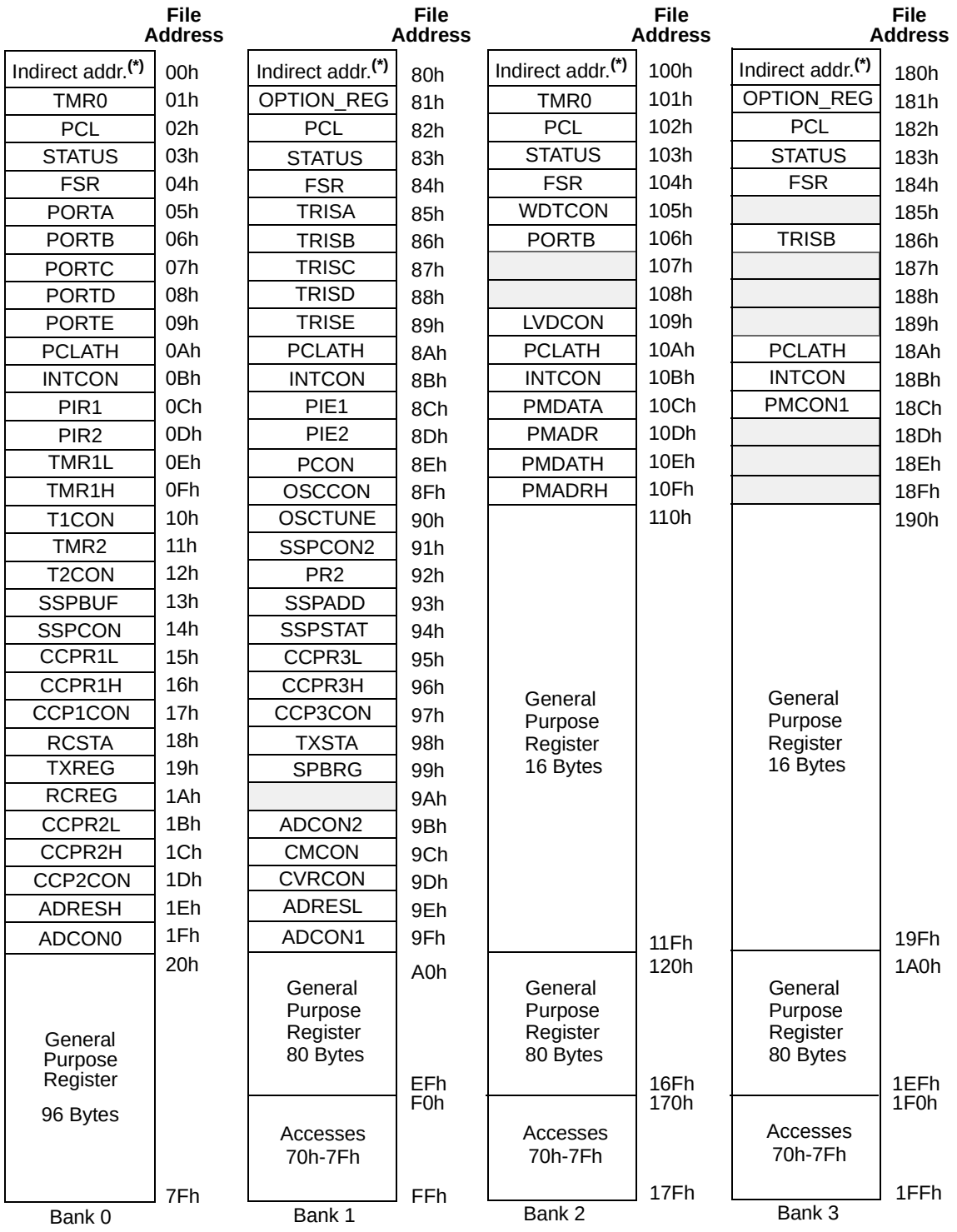
2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

3: This buffer is a Schmitt Trigger input when configured as a general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

4: This buffer is a Schmitt Trigger input when configured in RC Oscillator mode and a CMOS input otherwise.

5: Pin location of CCP2 is determined by the CCPMX bit in Configuration Word Register 1.

FIGURE 2-3: DATA MEMORY MAP FOR PIC16F747 AND THE PIC16F777



Unimplemented data memory locations read as '0'.
* Not a physical register.

2.2.2.6 PIE2 Register

The PIE2 register contains the individual enable bits for the CCP2 and CCP3 peripheral interrupts.

REGISTER 2-6: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2 (ADDRESS 8Dh)

R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
OSFIE	CMIE	LVDIE	—	BCLIE	—	CCP3IE	CCP2IE
bit 7							bit 0

bit 7 **OSFIE:** Oscillator Fail Interrupt Enable bit
1 = Enabled
0 = Disabled

bit 6 **CMIE:** Comparator Interrupt Enable bit
1 = Enabled
0 = Disabled

bit 5 **LVDIE:** Low-Voltage Detect Interrupt Enable bit
1 = LVD interrupt is enabled
0 = LVD interrupt is disabled

bit 4 **Unimplemented:** Read as '0'

bit 3 **BCLIE:** Bus Collision Interrupt Enable bit
1 = Enable bus collision interrupt in the SSP when configured for I^2C Master mode
0 = Disable bus collision interrupt in the SSP when configured for I^2C Master mode

bit 2 **Unimplemented:** Read as '0'

bit 1 **CCP3IE:** CCP3 Interrupt Enable bit
1 = Enables the CCP3 interrupt
0 = Disables the CCP3 interrupt

bit 0 **CCP2IE**: CCP2 Interrupt Enable bit
1 = Enables the CCP2 interrupt
0 = Disables the CCP2 interrupt

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

4.0 OSCILLATOR CONFIGURATIONS

4.1 Oscillator Types

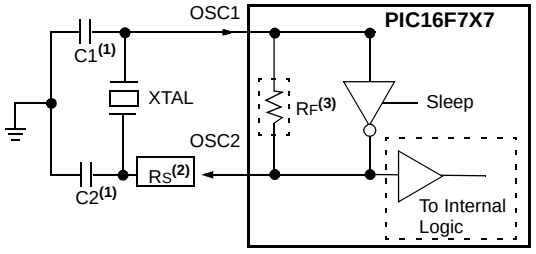
The PIC16F7X7 can be operated in eight different oscillator modes. The user can program three configuration bits (FOSC2:FOSC0) to select one of these eight modes (modes 5-8 are new PIC16 oscillator configurations):

1. LP Low-Power Crystal
2. XT Crystal/Resonator
3. HS High-Speed Crystal/Resonator
4. RC External Resistor/Capacitor with FOSC/4 output on RA6
5. RCIO External Resistor/Capacitor with I/O on RA6
6. INTIO1 Internal Oscillator with FOSC/4 output on RA6 and I/O on RA7
7. INTIO2 Internal Oscillator with I/O on RA6 and RA7
8. ECIO External Clock with I/O on RA6

4.2 Crystal Oscillator/Ceramic Resonators

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKI and OSC2/CLKO pins to establish oscillation (see Figure 4-1 and Figure 4-2). The PIC16F7X7 oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturer's specifications.

FIGURE 4-1: CRYSTAL OPERATION (HS, XT OR LP OSC CONFIGURATION)



Note 1: See Table 4-1 for typical values of C1 and C2.

2: A series resistor (RS) may be required for AT strip cut crystals.

3: RF varies with the crystal chosen (typically between 2 MΩ to 10 MΩ).

TABLE 4-1: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR (FOR DESIGN GUIDANCE ONLY)

Osc Type	Crystal Freq	Typical Capacitor Values Tested:	
		C1	C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	56 pF	56 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15 pF	15 pF
	20 MHz	15 pF	15 pF

Capacitor values are for design guidance only.

These capacitors were tested with the crystals listed below for basic start-up and operation. These values were not optimized.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

See the notes following this table for additional information.

Note 1: Higher capacitance increases the stability of oscillator but also increases the start-up time.

2: Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

3: Rs may be required in HS mode, as well as XT mode, to avoid overdriving crystals with low drive level specification.

4: Always verify oscillator performance over the VDD and temperature range that is expected for the application.

4.7 Power-Managed Modes

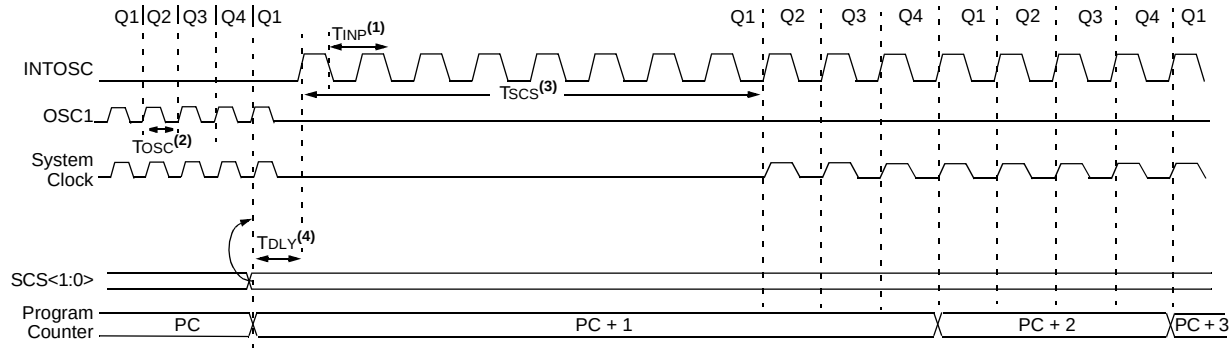
4.7.1 RC_RUN MODE

When SCS bits are configured to run from the INTRC, a clock transition is generated if the system clock is not already using the INTRC. The event will clear the OSTS bit and switch the system clock from the primary system clock (if SCS<1:0> = 00) determined by the value contained in the configuration bits, or from the T1OSC (if SCS<1:0> = 01) to the INTRC clock option and shut-down the primary system clock to conserve power. Clock switching will not occur if the primary system clock is already configured as INTRC.

If the system clock does not come from the INTRC (31.25 kHz) when the SCS bits are changed and the IRCF bits in the OSCCON register are configured for a frequency other than INTRC, the frequency may not be stable immediately. The IOFS bit (OSCCON<2>) will be set when the INTOSC or postscaler frequency is stable, after 4 ms (approx.).

After a clock switch has been executed, the OSTS bit is cleared, indicating a low-power mode and the device does not run from the primary system clock. The internal Q clocks are held in the Q1 state until eight falling edge clocks are counted on the INTRC oscillator. After the eight clock periods have transpired, the clock input to the Q clocks is released and operation resumes (see Figure 4-7).

FIGURE 4-7: TIMING DIAGRAM FOR XT, HS, LP, EC, EXTRC TO RC_RUN MODE



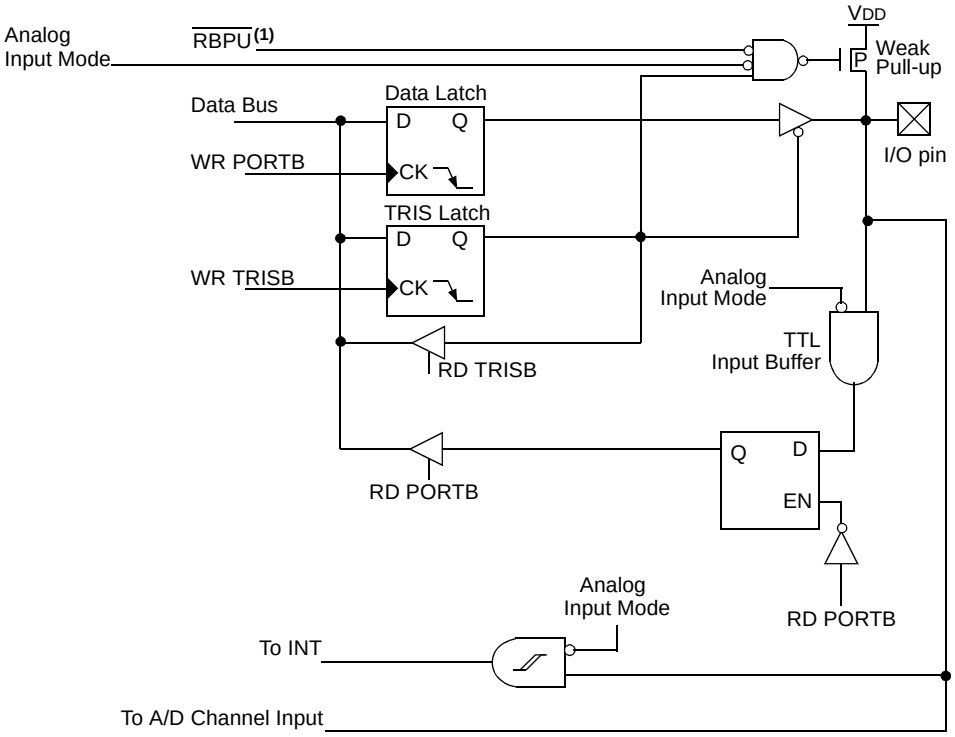
Note 1: TINP = 32 µs typical.
2: TOSC = 50 ns minimum.
3: TSCS = 8 TINP.
4: TDLY = 1 TINP.

TABLE 4-4: CLOCK SWITCHING MODES

Current System Clock	SCS bits<1:0> Modified to:	Delay	OSTS bit	IOFS bit	T1RUN bit	New System Clock	Comments
LP, XT, HS, T1OSC, EC, RC	10 (INTRC) FOSC<2:0> = LP, XT or HS	8 Clocks of INTRC	0	1(1)	0	INTRC or INTOSC or INTOSC Postscaler	The internal RC oscillator frequency is dependant upon the IRCF bits.
LP, XT, HS, INTRC, EC, RC	01 (T1OSC) FOSC<2:0> = LP, XT or HS	8 Clocks of T1OSC	0	N/A	1	T1OSC	T1OSCEN bit must be enabled.
INTRC T1OSC	00 FOSC<2:0> = EC or FOSC<2:0> = RC	8 Clocks of EC or RC	1	N/A	0	EC or RC	
INTRC T1OSC	00 FOSC<2:0> = LP, XT, HS	1024 Clocks + 8 Clocks of LP, XT, HS	1	N/A	0	LP, XT, HS	During the 1024 clocks, program execution is clocked from the secondary oscillator until the primary oscillator becomes stable.
LP, XT, HS	00 (Due to Reset) LP, XT, HS	1024 Clocks	1	N/A	0	LP, XT, HS	When a Reset occurs, there is no clock transition sequence. Instruction execution and/or peripheral operation is suspended unless Two-Speed Start-up mode is enabled, after which the INTRC will act as the system clock until the Oscillator Start-up Timer has expired.

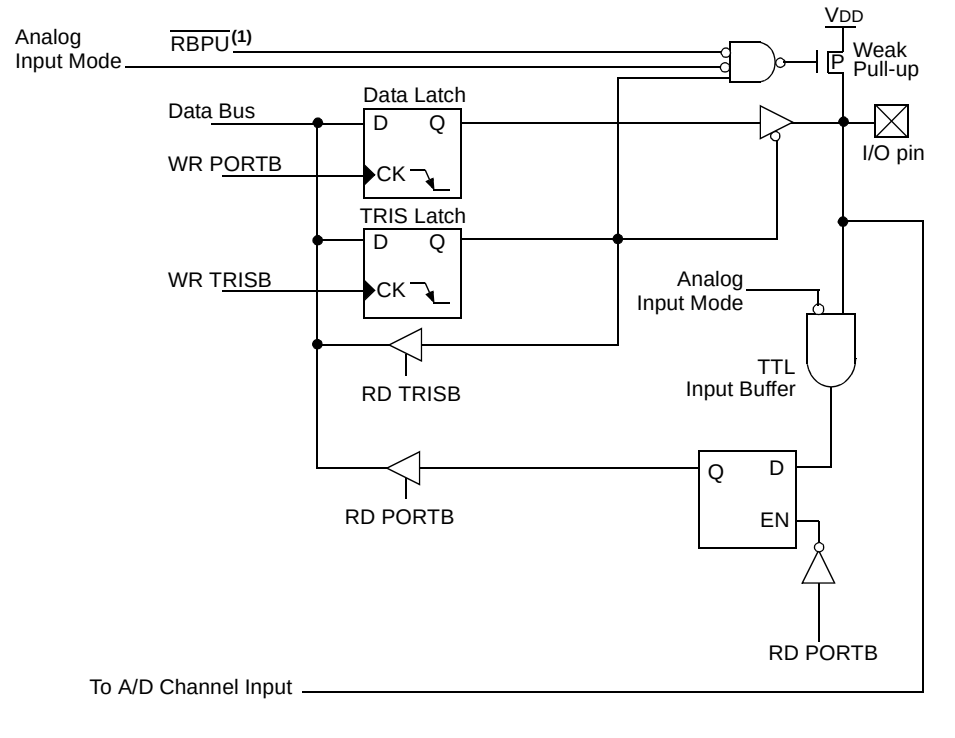
Note 1: If the new clock source is the INTOSC or INTOSC postscaler, then the IOFS bit will be set 4 ms (approx.) after the clock change.

FIGURE 5-8: BLOCK DIAGRAM OF RB0/INT/AN12 PIN



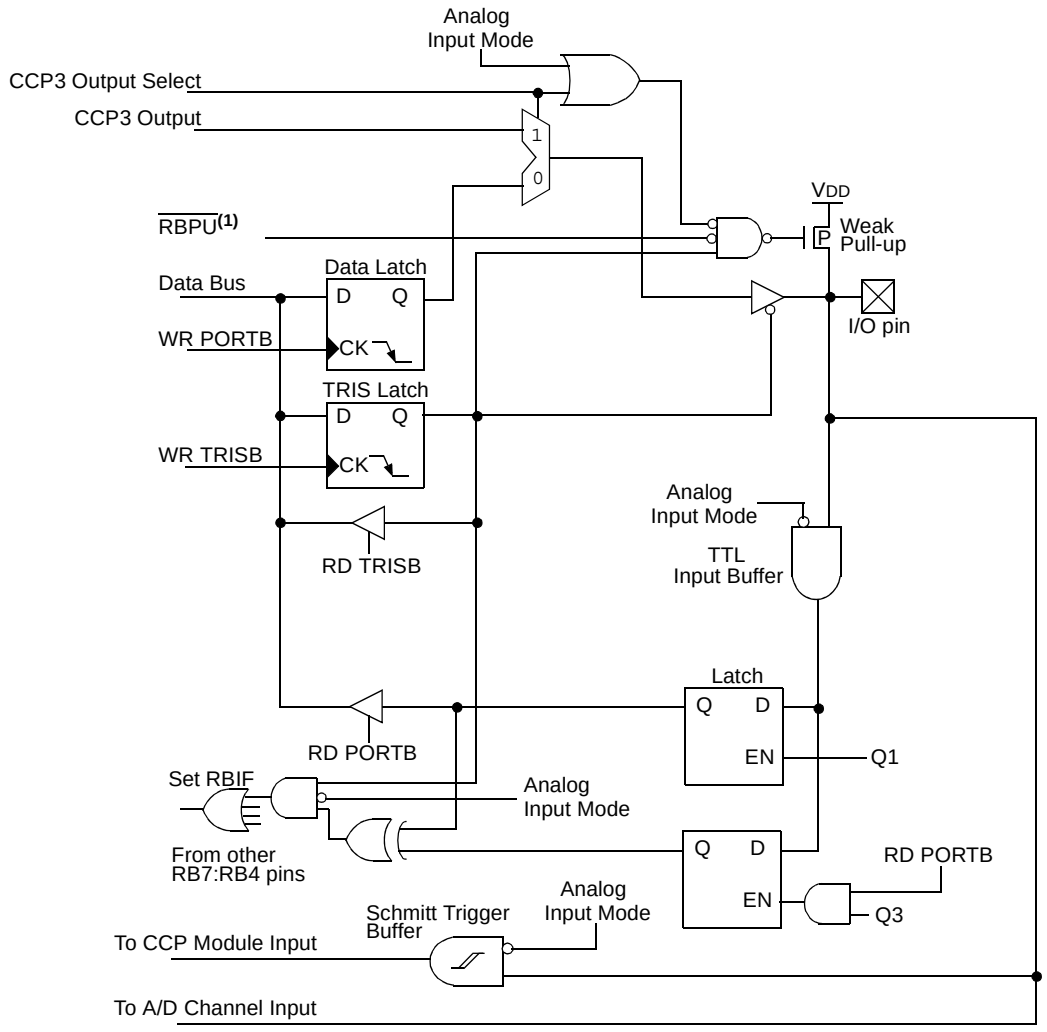
Note 1: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit.

FIGURE 5-9: BLOCK DIAGRAM OF RB1/AN10 PIN



Note 1: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit.

FIGURE 5-13: BLOCK DIAGRAM OF RB5/AN13/CCP3 PIN



Note 1: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit.

REGISTER 7-1: T1CON: TIMER1 CONTROL REGISTER (ADDRESS 10h)

U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{\text{T1SYNC}}$	TMR1CS	TMR1ON
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6 **T1RUN**: Timer1 System Clock Status bit
1 = System clock is derived from Timer1 oscillator
0 = System clock is derived from another source

bit 5-4 **T1CKPS<1:0>:** Timer1 Input Clock Prescale Select bits
11 = 1:8 Prescale value
10 = 1:4 Prescale value
01 = 1:2 Prescale value
00 = 1:1 Prescale value

bit 3 **T1OSCEN:** Timer1 Oscillator Enable Control bit
1 = Oscillator is enabled
0 = Oscillator is shut-off (the oscillator inverter is turned off to eliminate power drain)

bit 2 **T1SYNC:** Timer1 External Clock Input Synchronization Control bit
TMR1CS = 1:
1 = Do not synchronize external clock input
0 = Synchronize external clock input
TMR1CS = 0:
This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

bit 1 **TMR1CS:** Timer1 Clock Source Select bit
1 = External clock from pin RC0/T1OSO/T1CKI (on the rising edge)
0 = Internal clock (FOSC/4)

bit 0 **TMR1ON:** Timer1 On bit
1 = Enables Timer1
0 = Stops Timer1

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

10.3.3 ENABLING SPI I/O

To enable the serial port, SSP Enable bit, SSPEN (SSPCON<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPCON registers and then set the SSPEN bit. This configures the SDI, SDO, SCK and $\overline{SS}$ pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- SDI is automatically controlled by the SPI module
- SDO must have TRISC<5> bit cleared
- SCK (Master mode) must have TRISC<3> bit cleared
- SCK (Slave mode) must have TRISC<3> bit set
- $\overline{SS}$ must have TRISA<5> bit set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

10.3.4 TYPICAL CONNECTION

Figure 10-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data – Slave sends dummy data
- Master sends data – Slave sends data
- Master sends dummy data – Slave sends data

FIGURE 10-2: SPI MASTER/SLAVE CONNECTION

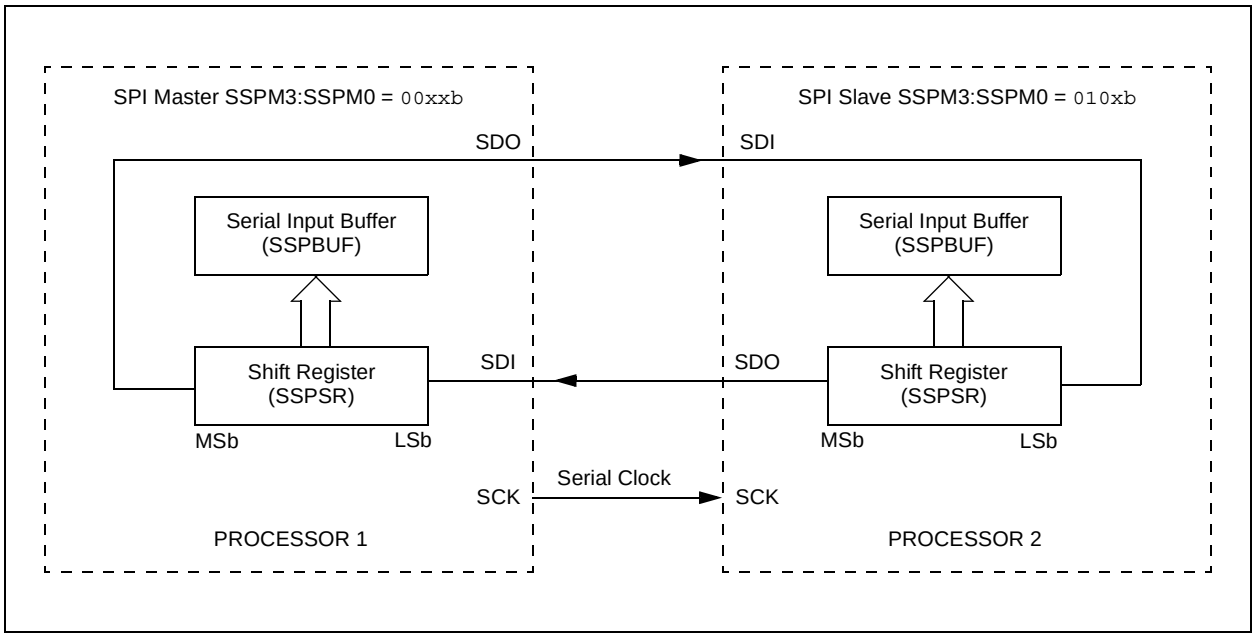
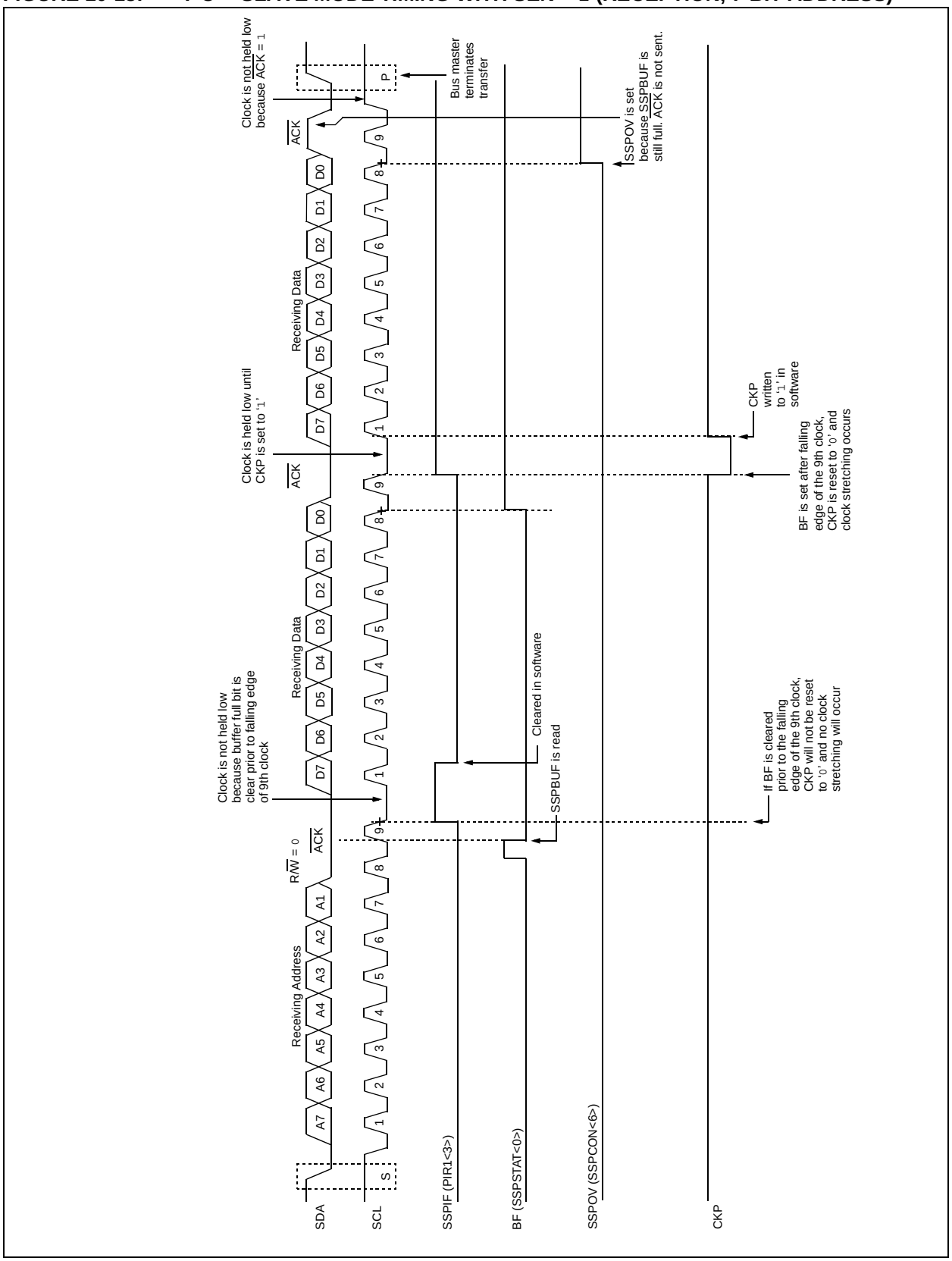


FIGURE 10-13: I²C™ SLAVE MODE TIMING WITH SEN = 1 (RECEPTION, 7-BIT ADDRESS)



REGISTER 11-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER (ADDRESS 18h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

bit 7 **SPEN:** Serial Port Enable bit
1 = Serial port enabled (configures RC7/RX/DT and RC6/TX/CK pins as serial port pins)
0 = Serial port disabled

bit 6 **RX9**: 9-bit Receive Enable bit
1 = Selects 9-bit reception
0 = Selects 8-bit reception

bit 5 **SREN**: Single Receive Enable bit
Asynchronous mode:
Don't care.
Synchronous mode – Master:
1 = Enables single receive
0 = Disables single receive
This bit is cleared after reception is complete.
Synchronous mode – Slave:
Don't care.

bit 4 **CREN**: Continuous Receive Enable bit
Asynchronous mode:
1 = Enables continuous receive
0 = Disables continuous receive
Synchronous mode:
1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)
0 = Disables continuous receive

bit 3 **ADDEN:** Address Detect Enable bit
Asynchronous mode 9-bit (RX9 = 1):
1 = Enables address detection, enables interrupt and load of the receive buffer when RSR<8> is set
0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

bit 2 **FERR**: Framing Error bit
1 = Framing error (can be updated by reading RCREG register and receiving next valid byte)
0 = No framing error

bit 1 **OERR**: Overrun Error bit
1 = Overrun error (can be cleared by clearing bit CREN)
0 = No overrun error

bit 0 **RX9D:** 9th bit of Received Data
Can be parity bit but must be calculated by user firmware.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

11.1 AUSART Baud Rate Generator (BRG)

The BRG supports both the Asynchronous and Synchronous modes of the AUSART. It is a dedicated 8-bit Baud Rate Generator. The SPBRG register controls the period of a free running 8-bit timer. In Asynchronous mode, bit BRGH (TXSTA<2>) also controls the baud rate. In Synchronous mode, bit BRGH is ignored. Table 11-1 shows the formula for computation of the baud rate for different AUSART modes which only apply in Master mode (internal clock).

Given the desired baud rate and FOSC, the nearest integer value for the SPBRG register can be calculated using the formula in Table 11-1. From this, the error in baud rate can be determined.

It may be advantageous to use the high baud rate (BRGH = 1) even for slower baud clocks. This is because the FOSC/(16(X + 1)) equation can reduce the baud rate error in some cases.

Writing a new value to the SPBRG register causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

11.1.1 SAMPLING

The data on the RC7/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin.

TABLE 11-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = FOSC/(64(X + 1))	Baud Rate = FOSC/(16(X + 1))
1	(Synchronous) Baud Rate = FOSC/(4(X + 1))	N/A

Legend: X = value in SPBRG (0 to 255).

TABLE 11-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
99h	SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

Legend: x = unknown, — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

The value in the ADRESH/ADRESL registers is not modified for a Power-on Reset. The ADRESH/ADRESL registers will contain unknown data after a Power-on Reset.

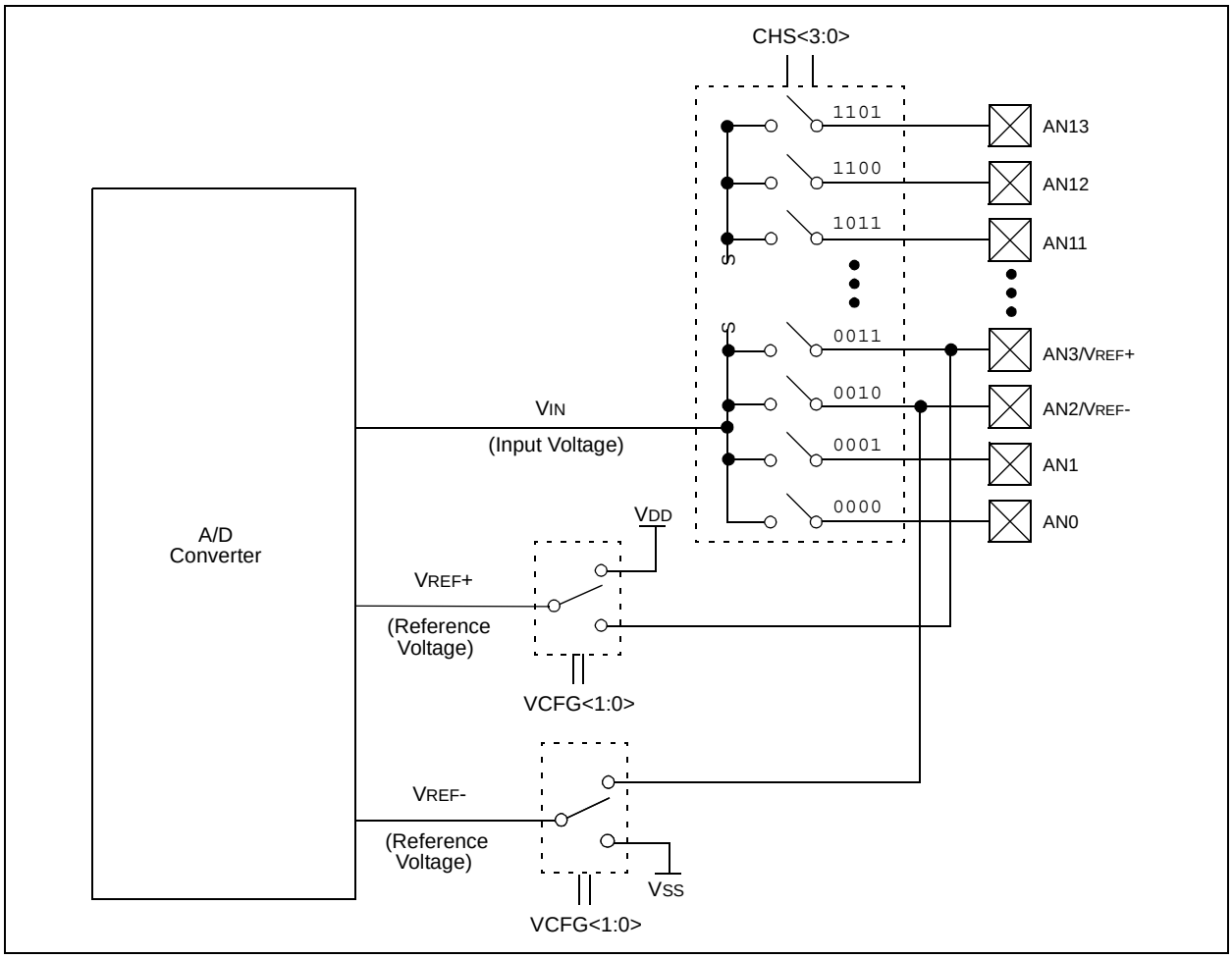
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 12.1 "A/D Acquisition Requirements"**. After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/$\overline{\text{DONE}}$ bit and the actual start of the conversion.

The following steps should be followed to do an A/D conversion:

1. Configure the A/D module:
   - Configure analog pins, voltage reference and digital I/O (ADCON1)
   - Select A/D input channel (ADCON0)
   - Select A/D acquisition time (ADCON2)
   - Select A/D conversion clock (ADCON0)
   - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
   - Clear ADIF bit
   - Set ADIE bit
   - Set PEIE bit
   - Set GIE bit
3. Wait the required acquisition time (if required).
4. Start conversion:
   - Set GO/$\overline{\text{DONE}}$ bit (ADCON0 register)
5. Wait for A/D conversion to complete, by either:
   - Polling for the GO/$\overline{\text{DONE}}$ bit to be cleared

   OR
   - Waiting for the A/D interrupt
6. Read A/D Result registers (ADRESH:ADRESL); clear bit ADIF (if required).
7. For next conversion, go to step 1 or step 2 as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before the next acquisition starts.

FIGURE 12-1: A/D BLOCK DIAGRAM



12.4 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT2:ACQT0 (ADCON2<5:3>) and ADCS2:ADCS0 (ADCON1<6>, ADCON0<7:6>) bits should be updated in accordance with the power-managed mode clock that will be used. After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in Sleep mode requires the A/D RC clock to be selected. If bits ACQT2:ACQT0 are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry to Sleep mode.

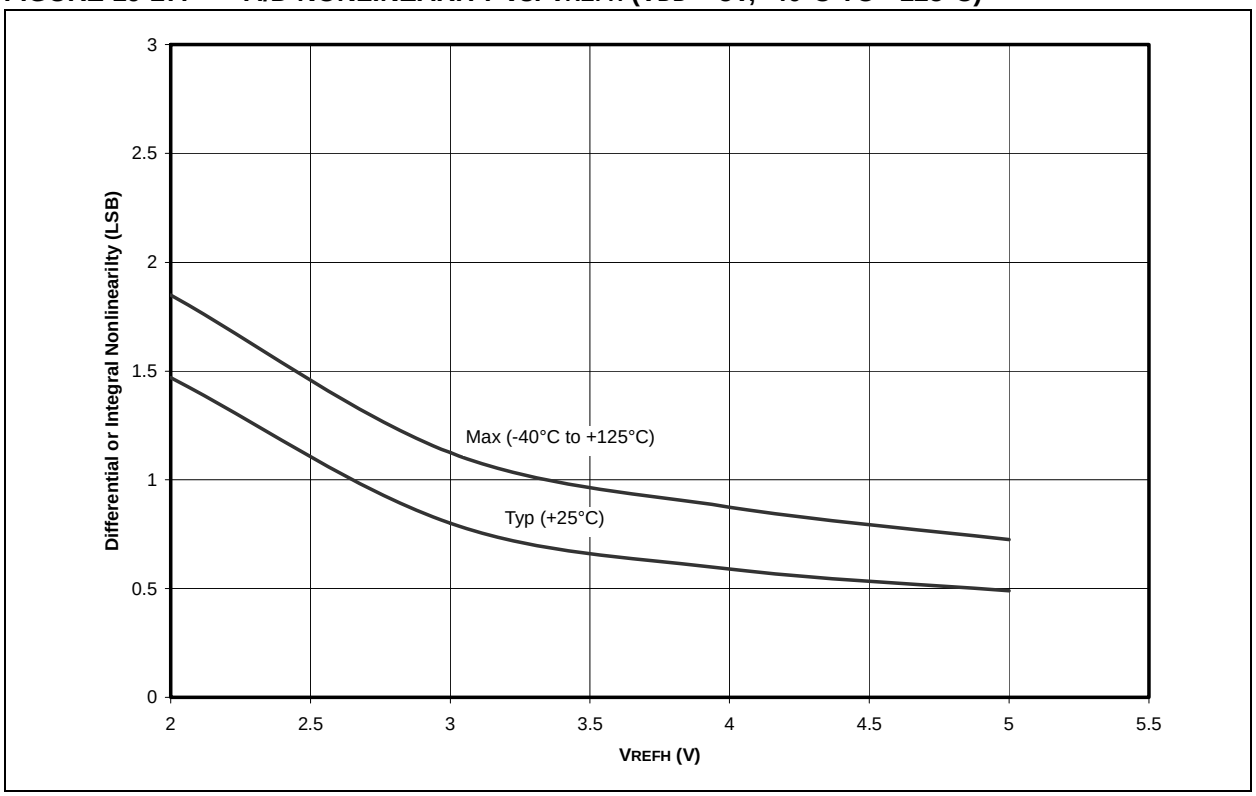
12.5 Configuring Analog Port Pins

The ADCON1, TRISA, TRISB and TRISE registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (V_{OH} or V_{OL}) will be converted.

The A/D operation is independent of the state of the CHS2:CHS0 bits and the TRIS bits.

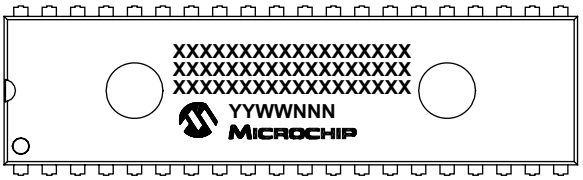
Note 1:	When reading the Port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.
2:	Analog levels on any pin that is defined as a digital input, but not as an analog input, may cause the digital input buffer to consume current that is out of the device's specification.

FIGURE 19-27: A/D NONLINEARITY vs. VREFH (VDD = 5V, -40°C TO +125°C)

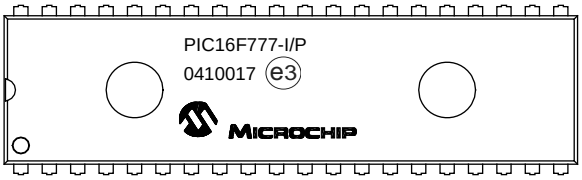


Package Marking Information (Continued)

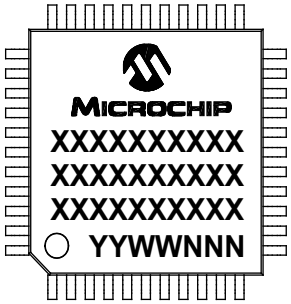
40-Lead PDIP (600 mil)



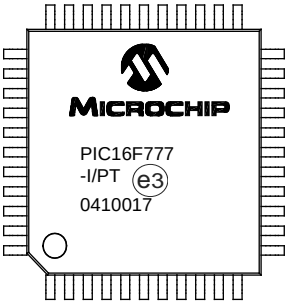
Example



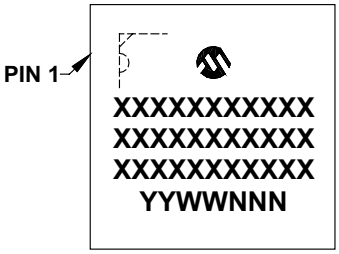
44-Lead TQFP (10x10x1 mm)



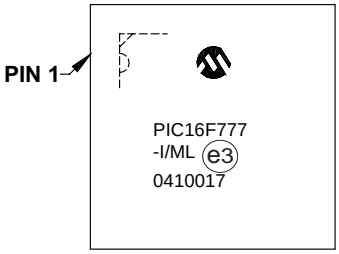
Example



44-Lead QFN (8x8x0.9 mm)



Example



NOTES: